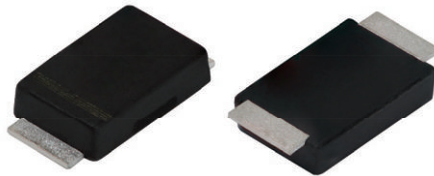


## Hyperfast Rectifier, 2 A FRED Pt<sup>®</sup>

### eSMP<sup>®</sup> Series



Top View

Bottom View

### SlimSMAW (DO-221AD)

### LINKS TO ADDITIONAL RESOURCES



3D Models

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	2 A
$V_R$	100 V, 200 V
$V_F$ at $I_F$	0.69 V
$I_{FSM}$	60 A
$t_{rr}$ (typ.)	15 ns
$T_J$ max.	175 °C
Package	SlimSMAW (DO-221AD)
Circuit configuration	Single

### FEATURES

- Low profile package
- Ideal for automated placement
- Low forward voltage drop, low power losses
- Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Class 2 whisker test
- Compatible to SOD-128 package case outline
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
 COMPLIANT  
 HALOGEN  
**FREE**

### DESCRIPTION / APPLICATIONS

For use in high frequency, freewheeling, DC/DC converters, PFC, and in snubber industrial, and automotive applications.

### MECHANICAL DATA

**Case:** SlimSMAW (DO-221AD)

Molding compound meets UL 94 V-0 flammability rating  
 Halogen-free, RoHS-compliant

**Terminals:** matte tin plated leads, solderable per J-STD-002

**Polarity:** color band denotes cathode end

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Peak repetitive reverse voltage	$V_{RRM}$		100	V	
			200		
Average rectified forward current	$I_{F(AV)}$ <sup>(1)</sup>	$T_C = 151\text{ °C}$	2	A	
Non-repetitive peak surge current	$I_{FSM}$	$T_J = 25\text{ °C}$ , 10 ms sine pulse wave	60		
Operating junction and storage temperatures	$T_J, T_{Stg}$		-55 to +175	°C	

#### Note

<sup>(1)</sup> Mounted on infinite heatsink

ELECTRICAL SPECIFICATIONS ( $T_J = 25\text{ °C}$ unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Breakdown voltage, blocking voltage	$V_{BR}, V_R$	$I_R = 100\ \mu\text{A}$	100	-	-	V	
			200	-	-		
Forward voltage, per diode	$V_F$	$I_F = 2\text{ A}$	-	0.86	0.93		
		$I_F = 2\text{ A}, T_J = 150\text{ °C}$	-	0.69	0.75		
Reverse leakage current, per diode	$I_R$	$V_R = V_R$ rated	-	-	2	$\mu\text{A}$	
		$T_J = 150\text{ °C}, V_R = V_R$ rated	-	-	20		
Junction capacitance	$C_T$	$V_R = 200\text{ V}$	-	12	-	pF	



DYNAMIC RECOVERY CHARACTERISTICS (T <sub>J</sub> = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> = 1.0 A, di <sub>F</sub> /dt = 50 A/μs, V <sub>R</sub> = 30 V	-	22	-	ns
		I <sub>F</sub> = 1.0 A, di <sub>F</sub> /dt = 100 A/μs, V <sub>R</sub> = 30 V	-	15	-	
		I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1A, I <sub>rr</sub> = 0.25 A	-	-	28	
		T <sub>J</sub> = 25 °C	-	16	-	
		T <sub>J</sub> = 125 °C	-	26	-	
Peak recovery current	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C	-	2.7	-	A
		T <sub>J</sub> = 125 °C	-	3.4	-	
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C	-	20	-	nC
		T <sub>J</sub> = 125 °C	-	43	-	

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-55	-	175	°C
Thermal resistance, junction to mount	R <sub>thJM</sub> <sup>(1)</sup>	Infinite heatsink	-	12	15	°C/W
Thermal resistance, junction to ambient	R <sub>thJA</sub>	Device mounted on FR4 PCB, 2 oz. standard footprint	-	120	150	
Marking device	VS-2EYH01-M3	Case style SlimSMAW (DO-221AD)	2H1			
	VS-2EYH02-M3		2H2			

**Note**

<sup>(1)</sup> Thermal resistance junction to mount follows JEDEC® 51-14 transient dual interface test method (TDIM)

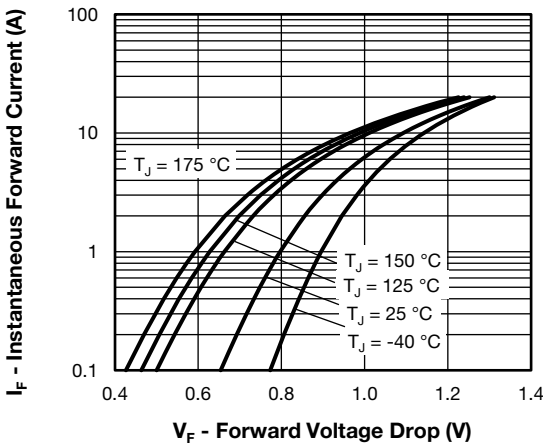


Fig. 1 - Typical Forward Voltage Drop Characteristics

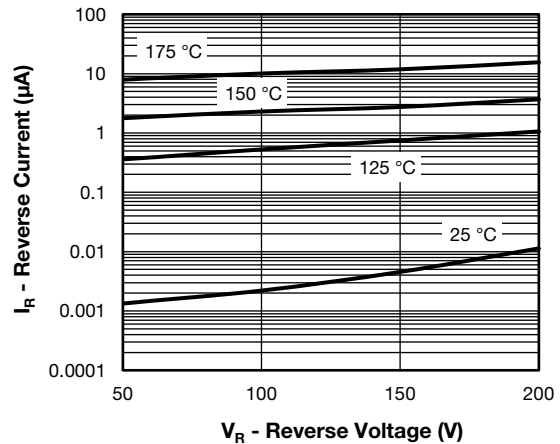


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

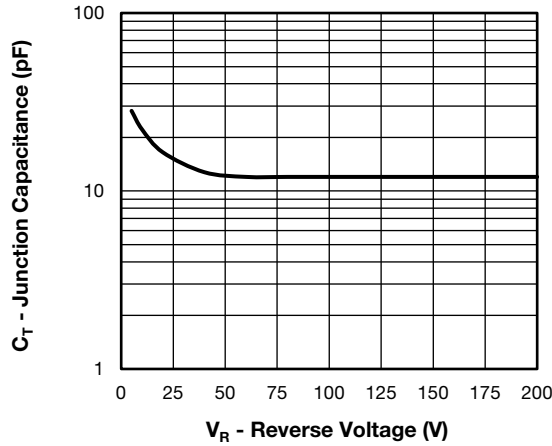


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

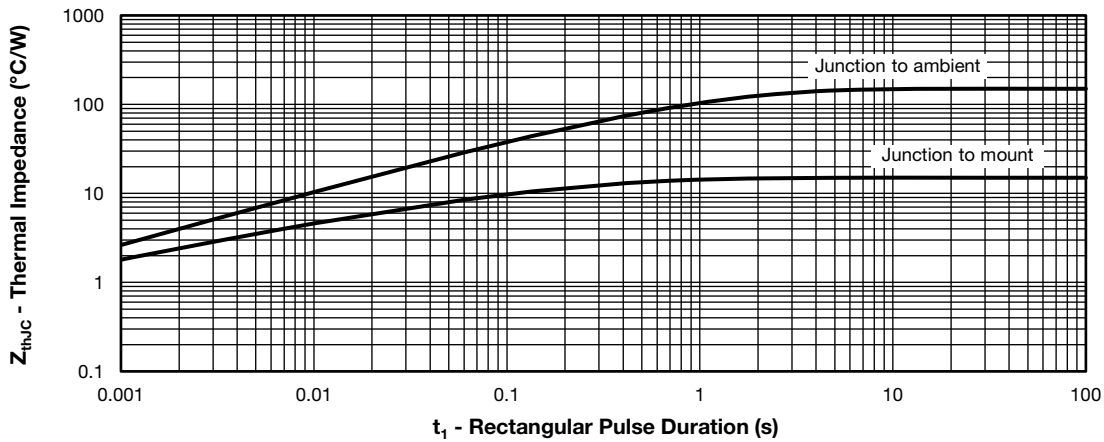


Fig. 4 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics

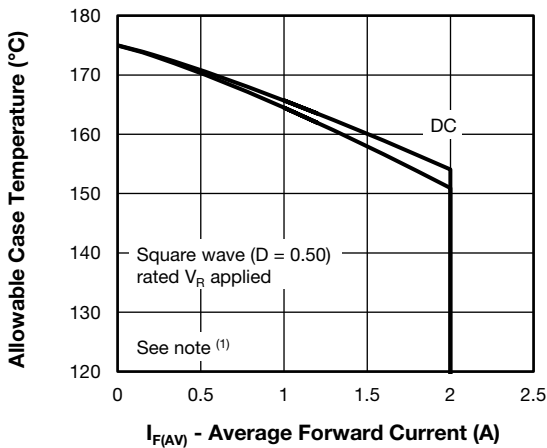


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

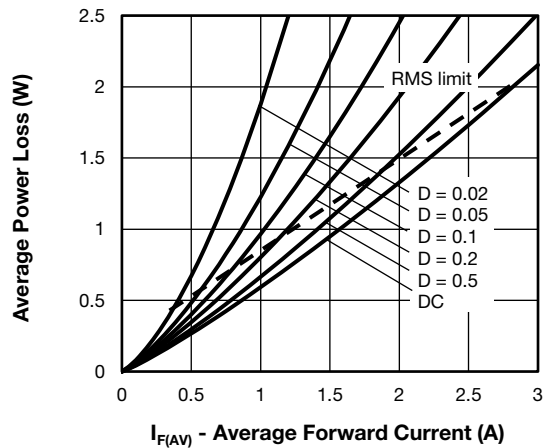


Fig. 6 - Forward Power Loss Characteristics

**Note**

- (1) Formula used:  $T_C = T_J - (P_d + P_{dREV}) \times R_{thJC}$ ;
- $P_d$  = forward power loss =  $I_{F(AV)} \times V_{FM}$  at  $(I_{F(AV)}/D)$  (see fig. 5);
- $P_{dREV}$  = inverse power loss =  $V_{R1} \times I_R (1 - D)$ ;  $I_R$  at  $V_{R1}$  = rated  $V_R$

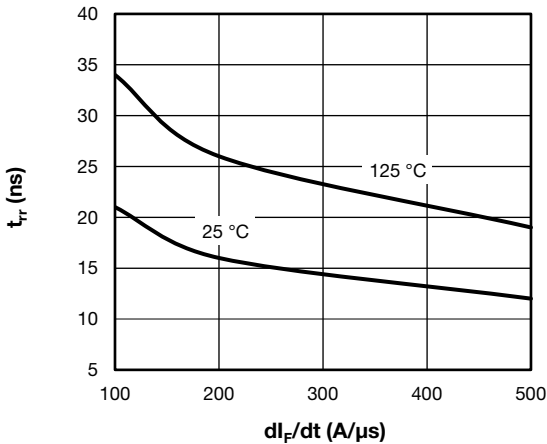


Fig. 7 - Typical Reverse Recovery Time vs.  $di_F/dt$

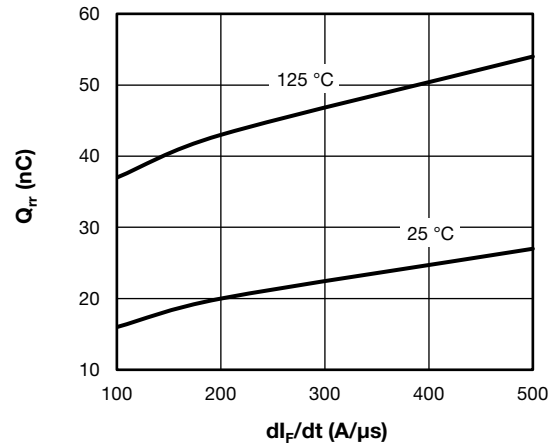


Fig. 8 - Typical Stored Charge vs.  $di_F/dt$

**ORDERING INFORMATION TABLE**

Device code	<b>VS-</b>	<b>2</b>	<b>E</b>	<b>Y</b>	<b>H</b>	<b>02</b>	<b>-</b>	<b>M3</b>
	①	②	③	④	⑤	⑥		⑦

- 1** - Vishay Semiconductors product
- 2** - Current rating (2 = 2 A)
- 3** - Circuit configuration:  
E = single diode
- 4** - Y = SlimSMAW (DO-221AD)
- 5** - Process type,  
H = hyperfast recovery
- 6** - Voltage code (02 = 200 V)
- 7** - M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	PACKAGING DESCRIPTION
VS-2EYH01-M3/H	0.033	H	3500	7" diameter plastic tape and reel
VS-2EYH01-M3/I	0.033	I	14 000	13" diameter plastic tape and reel
VS-2EYH02-M3/H	0.033	H	3500	7" diameter plastic tape and reel
VS-2EYH02-M3/I	0.033	I	14 000	13" diameter plastic tape and reel

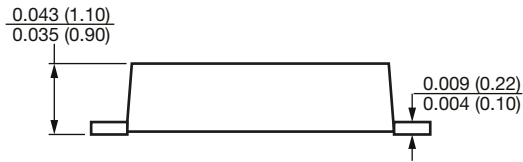
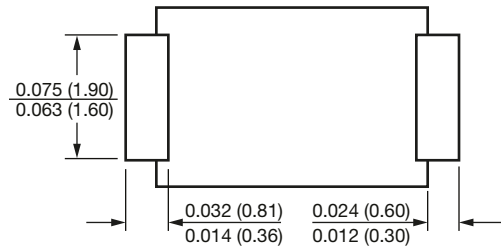
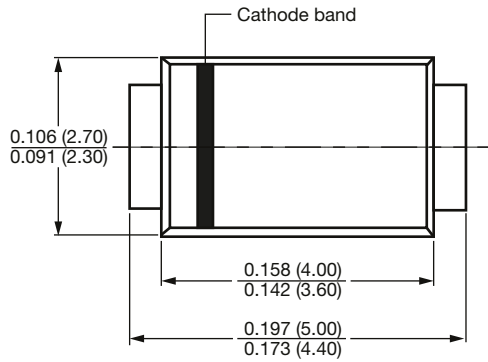
LINKS TO RELATED DOCUMENTS	
Dimensions	<a href="http://www.vishay.com/doc?96582">www.vishay.com/doc?96582</a>
Part marking information	<a href="http://www.vishay.com/doc?95562">www.vishay.com/doc?95562</a>
Packaging information	<a href="http://www.vishay.com/doc?88869">www.vishay.com/doc?88869</a>
SPIICE model	<a href="http://www.vishay.com/doc?96585">www.vishay.com/doc?96585</a>



## SlimSMAW (DO-221AD)

**DIMENSIONS** in inches (millimeters)

### SlimSMAW (DO-221AD)



**Mounting pad layout**



## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.